METHOD OF DECONTAMINATING A CONTAMINATED FLUID BY USING PHOTOCATALYTIC PARTICLES

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ABSTRACT

A system for decontaminating the contaminated fluid by using photocatalytic particles. The system includes a reactor tank for holding the contaminated fluid and the photocatalytic particles suspended in the contaminated fluid to form a slurry. Light irradiates the surface of the slurry, thereby activating the photocatalytic properties of the particles. The system also includes stirring blades for continuously agitating the irradiated fluid surface and for maintaining the particles in a suspended state within the fluid. The system also includes a cross flow filter for segregating the fluid (after decomposition) from the semiconductor powder. The cross flow filter is occasionally back flushed to remove any semiconductor powder that might have caked on the filter. The semiconductor powder may be recirculated back to the tank for reuse, or may be stored for future use. A series of such systems may be used to gradually decompose a chemical in the fluid. Preferably, the fluid is pretreated to remove certain metal ions which interfere with the photocatalytic process. Such pretreatment may be accomplished by dispersing semiconductor particles within the fluid, which adsorb ions or photodeposit the metal as the free metal or its insoluble oxide or hydroxide, and then removing the semiconductor particles together with the adsorbed metal ions/oxide/hydroxide/free metal from the fluid. A method of decontaminating a contaminated fluid is also disclosed.

9 Claims, 13 Drawing Sheets
METHOD OF DECONTAMINATING A CONTAMINATED FLUID BY USING PHOTOCATALYTIC PARTICLES

REFERENCE TO GOVERNMENT CONTRACT

This invention was made with Government support under Contract NAS-17987, awarded by NASA. The Government has certain rights in this invention.

CROSS REFERENCE TO RELATED APPLICATIONS


A relatively new technology uses semiconductor powders to carry out photocatalytic processes. Irradiation of the semiconductor with light of energy equal to or greater than the band gap results in the creation of electrons in the semiconductor conduction band and holes in the valence band following by trapping of the separated charges in shallow traps at the semiconductor powder surface. The injection of these electrons and holes into the fluid region surrounding the semiconductor particles' surface causes electrochemical modification of substances within this region. Such technology has been used in at least the following photocatalytic processes the photo-Kolbe reaction in which acetic acid is decomposed to methane and carbon dioxide, the photoelectrolysis of amino acids from methane-ammonia-water mixtures, the decomposition of adipic acid to carbon dioxide, butane, and valeric acid; the production of hydrogen from several aliphatic and aromatic compounds (including fossil fuels); with water; the degradation of chlorinated hydrocarbons to carbon dioxide and hydrochloric acid; the oxidation of cyanide; the sterilization of aqueous microbial cells; and the deposition of metals from their aqueous ions.

As is well known, catalytic action results when a catalyst agent reduces the activation energy required to drive a chemical reaction to completion. In ordinary heterogeneous catalysis, the activation energy, Ea, is provided by heat and the catalyst reduces the amount of heat required. Hence, the catalyst permits driving the chemical reaction at a faster rate at a given temperature or lowers the temperature at which a given rate occurs. In contrast, in photocatalysis, Ea is provided by the photon energy of the incident band-gap light. Light has a very high free energy content, and it can be converted into high energy electron excitation when absorbed by semiconductors. Thus, optically excited semiconductors can drive chemical reactions even at room temperature by providing Ea in the form of high energy electrons and holes.

Photocatalysis is distinguishable from ordinary heterogeneous catalysis in that it employs visible and ultraviolet (UV) radiation to facilitate chemical reactions rather than thermal energy (i.e., heat). Although the infrared (IR) part of the spectrum is also electromagnetic radiation, its absorption by matter normally results in heating. Absorption of IR radiation will result in the heating of the catalyst or chemical reactants. In ordinary catalysis, thermal energy derived from IR irradiation, direct heating or even microwave absorption manifests itself as an elevated temperature (increased energy of translational, rotational, and vibrational modes) of the chemical reactants and the catalyst for the provision of the reaction's activation energy. The optical properties (i.e., the ability of radiation to effect electronic excitations) of the catalyst are not germane. In ordinary catalysis the catalyst may even be a semiconducting material. However, this is an incidental property, and no particular use of its optical properties is made. The ordinary catalyst is optically passive, and only provides an adsorbing surface for diminishing the activation energy of reactants.

As a result, the role played by IR, visible, and UV light in ordinary catalysis and photocatalysis is fundamentally different. In distinction from ordinary catalysis, in heterogeneous photocatalysis, the catalyst's optical properties are paramount. The photocatalyst must be a semiconductor. By absorption of band-gap light, electron and hole charge carrier pairs are produced within the photocatalyst particles. These charge carriers then perform redox reactions with the chemical species.

Ordinary catalytic properties, as described above, may also be a feature of the photocatalytic process. Additionally, ordinary thermal processes may also play a secondary role in reaction kinetics (e.g., absorption of any wavelength light could result in some system heating). However, the distinguishing feature of photocatalytic reactions is that the activation energy of reaction results primarily from optical processes and the subsequent generation and transfer of electron holes (i.e., redox chemistry) rather than simple heating.


Photocatalytic processes have also been used to decompose into relatively harmless products, the following chemicals: trichloroethene, catechol, acetic acid, benzonitrile, phenol, caprolactam, acetone, methanol, urea, dichloromethane, chloroform, carbon tetrachlo-
ride, trichloromethane, 4-chlorophenol, pentachlorophenol, polychlorinated biphenyl, dioxins, p-dichlorobenzene, 1,1-dibromoethane, and 1,2-dibromoethane. Photoelectrochemical processes employing irradiated semiconductor slurries have been investigated for the removal of metals by photoelectrodeposition; for example chromium (VI), copper (II), cadmium, lead, arsenic, and mercury.

It is believed that all present systems utilizing the technology maintain the chemical compounds to be modified in a gas mixture, gas solution, a gas/liquid mixture, a liquid, or another fluid for the most effective contact between the chemical compound and the semiconductor powder. In most of the systems, the semiconductor powder itself is also suspended and mixed in the gas or liquid and is maintained in such suspended and mixed condition by bubbling a gas through a liquid, constantly stirring the fluid with a magnetic stirrer, or example, or continuously circulating the fluid with a pump. A process with suspending and mixing the semiconductor powder in a gas or liquid is that some means must be utilized to maintain the semiconductor powder in a suspended and mixed condition and that the semiconductor powder must at some time be segregated from the modified chemical compound, especially if the semiconductor powder is to be reused. In another system, the photocatalyst can be immobilized onto a substrate. If the photocatalyst powder particles are small enough, they can be made to effectively adhere to the substrate by relatively weak forces. Another method of immobilization is to cause chemical binding of the photocatalyst to the substrate Although immobilizing the photocatalyst solves the problem of powder segregation after completion of chemical reactions, the immobilized system can suffer from inefficient light usage due to mass transfer problems or the photocatalyst does not effect complete separation, and centrifuge equipment is cumbersome to use and is expensive. Also, the centrifuge process may require that the operation of the photocatalytic process be disrupted in a non-continuous operation. Consequently, in any commercial, large scale, substantially continuous photocatalytic operation in which the semiconductor powders are suspended in the fluid containing the substances to be decomposed, there is a need for an effective and efficient particle separation system that will segregate the semiconductor powder from the fluid after the decomposition has been achieved.

SUMMARY OF THE INVENTION

The present invention relates to a system for decontaminating a contaminated fluid by using photocatalytic particles. The system includes a reactor for holding the contaminated fluid with the photocatalytic particles suspended in the contaminated fluid to form a slurry. Light irradiates the surface of the slurry, thereby activating the photocatalytic properties of the particles. The system also includes stirring impellers for continuously agitating the irradiated fluid surface and for maintaining the particles in a suspended state within the fluid. The system also includes a cross flow filter for segregating the fluid (after decomposition) from the semiconductor powder. The cross flow filter is occasionally back flushed to remove any semiconductor powder that might have caked on the filter. The semiconductor powder may be recirculated back to a reactor for reuse, or may be stored for future use. A series of such systems may be used to gradually decompose a chemical in the fluid. Preferably, the fluid is pretreated to remove certain metal ions which interfere with the photocatalytic process. Such pretreatment may be accomplished by dispersing semiconductor particles within the fluid. The particles can either simply adsorb or photoelectrochemically remove the metal ions which are subsequently removed with the particles from the fluid.

A method of decontaminating a contaminated fluid is also disclosed.

BRIEF DESCRIPTION OF THE DRAWINGS

The present invention will be described with reference to the accompanying drawings, wherein:

FIG. 1 is a schematic diagram of a single reactor system for decontaminating a contaminated fluid by using photocatalytic powder particles according to one embodiment of the present invention;

FIG. 2A is a side schematic illustration of a single reactor for decontaminating a contaminated fluid by using photocatalytic powder particles in which the reactor bottom is formed by excavating the ground and employing a flexible liner in accordance with another embodiment of the present invention;

FIG. 2B is a top schematic illustration of seven of the reactors shown in FIG. 2A packed together in a hexagonal array;

FIG. 2C is a perspective illustration of the hexagonal array of reactors shown in FIG. 2B;

FIG. 3 is a cross sectional illustration showing the air/water interface within a reactor and the surface turbulence generated by an impeller used in the reactors in accordance with the present invention;

FIG. 4A is a side schematic view of an impeller that may be used to agitate the surface of the slurry comprised of the contaminated fluid and the photocatalytic particles suspended therein;

FIG. 4B is an end view of the impeller shown in FIG. 4A;

FIG. 5A is a side schematic view of another impeller that may be used to agitate the slurry;

FIG. 5B is an end view of the impeller shown in FIG. 5A;

FIG. 6A is a side schematic view of another impeller that may be used to agitate the slurry surface;

FIG. 6B is an end view of the impeller shown in FIG. 6A;

FIG. 7A is a side schematic view of yet another impeller that may be used to agitate the slurry surface;
FIG. 7B is an end view of the impeller shown in FIG. 7A.

FIG. 8A is a side schematic view of another impeller that may be used to agitate the slurry surface;

FIG. 8B is an end view of the impeller shown in FIG. 8A.

FIG. 9A is a side schematic view of another impeller that may be used to agitate the slurry surface;

FIG. 9B is an end view of the impeller shown in FIG. 9A.

FIG. 10A is a side schematic view of another impeller that may be used to agitate the slurry surface;

FIG. 11 is a side schematic view of a two impeller system that may be used to agitate the slurry surface and the reactor bottom, preferably with the upper impeller rotating in a direction opposite to the rotational direction of the lower impeller;

FIG. 12A is a side schematic view of a two impeller system that may be used to agitate the slurry surface and the reactor bottom, preferably with the impeller having radially shorter blades rotating faster than the other impeller;

FIG. 12B is a top schematic view of the two impeller system shown in FIG. 12A;

FIG. 13 is a partial perspective view of an air driven impeller disposed near the bottom of the reactor;

FIG. 14 is a schematic diagram of a centrifugal pump and cross flow filter used to segregate the photocatalytic powder particles from the decontaminated fluid;

FIG. 15 is a top schematic view of a continuously stirred tank reactor and a cross flow filter for decontaminating a contaminated fluid by utilizing photocatalytic powder particles in a co-current mode according to an embodiment of the present invention;

FIG. 16 is a top schematic an extended reactor and module system employing several of the reactors and modules shown in FIG. 15;

FIG. 17 is a top view schematic of a pretreatment reactor for the removal of metal ions from the contaminated fluid;

FIG. 18 is a schematic diagram of a two reactor system comprising a module for decontaminating a contaminated fluid by using photocatalytic powder particles in a counter-current mode according to yet another embodiment of the present invention; and

FIG. 19 is a photocatalytic counter-current system including organics oxidation modules and a photocatalytic metal ion removal pretreatment reactor

DESCRIPTION OF A PREFERRED EMBODIMENT

There is shown in FIG. 1 a schematic diagram of a single reactor system for decontaminating contaminated fluid by using photocatalytic particles. As used in the present invention, a "contaminated" fluid is a fluid that contains undesirable organic and/or inorganic products and/or possibly microbial cells or other microorganisms. Although the contaminants are undesirable in the sense that they are usually toxic when ingested or contacted by humans, the term "undesirable" should not be understood to be restricted to such toxic substances. The term "decontaminated" fluid means that the undesirable substances in the fluid have been altered or modified into a desireable or an acceptable substance, again, usually a substance that is non-toxic. Normally such alteration or modification of any organic substance is achieved by decomposing the substance into by-products having a smaller molecular weight than the original contaminated substance. Inorganic substances are removed by either adsorption or photodeposition, whereas microorganisms are killed.

The system shown in FIG. 1 includes a cylindrically shaped reactor 10 fashioned of plastic and having a diameter of between about thirty-three inches and seven hundred feet. The reactor 10 possesses a depth or length of about three and one-half inches to approximately one foot or more, depending on reactor diameter, and is open at one longitudinal end thereof. Such a reactor is referred to throughout this specification as a continuously stirred tank reactor (CSTR). The contaminated fluid is introduced into the CSTR 10 via a conduit 12, and then a semiconductor powder such as anatase titanium dioxide is mixed into the contaminated fluid within the CSTR 10. Alternatively, the semiconductor particles may be previously dispersed within the contaminated fluid before introducing the contaminated fluid into the CSTR 10, or the semiconductor powder may be disposed within the CSTR 10 when the contaminated fluid is introduced into the CSTR 10 by an automated catalyst feeder (ACF) as a slurry or as a dry powder.

As the scale of the CSTR increases, it may be desirable to fabricate the CSTR from materials other than plastic. In particular, a cost effective method for fabricating a large scale solar driven photocatalytic CSTR may be to excavate a level, shallow, round depression in the ground, then lining the soil with an inert polymer liner such as hypalon or other inert material, as shown in FIG. 2 Conventional materials such as concrete could be used to fabricate CSTRs either above or below the ground. In order to optimize usage of real estate, the round CSTRs may be placed on the surface in a hexagonal packed array as shown in FIGS. 2B and 2C.

The open longitudinal end of the CSTR 10 is disposed vertically upward so that the surface of the slurry comprised of the contaminated fluid and the semiconductor particles suspended therein may be illuminated by sunlight or some other light source capable of causing the semiconductor powders to be photocatalytically active. It should be appreciated that in the system, the CSTR 10 may be replaced by reactors having completely different geometries and may be irradiated by various natural and artificial light sources, including the sun, and that the reactors may be completely enclosed and have transparent walls, such that the slurry may be irradiated within the reactor 10 from any one or more of several directions. In the case of some reactors, mixing the fluid by impellers may be impractical due to geometric constraints. In such cases, mixing may be achieved by using a pump to force fluid through the reactor, and the reactor is designed to facilitate suitable slurry mixing by means of the pump.

The photocatalytically active semiconductor powder gradually decontaminates the fluid. The degree of decontamination may be monitored by a suitable detector (not shown) to determine when a desireable degree of decontamination has been achieved within the slurry in the CSTR 10. The rate of decontamination depends upon the types of contaminants, the contaminant concentrations, the relative amounts of contaminated substances within the fluid, the relative amounts of semiconductor powder within the slurry, the magnitude of...
irradiation having the desired wavelength directed onto the slurry, the slurry pH, and other factors.

The inventors have discovered through experimentation that when light irradiates a slurry surface containing the contaminated fluid and the semiconductor particles, the irradiation causes the semiconductor powders to become photocatalytically active within only one or two millimeters of the slurry surface being irradiated at nominal loadings of about 0.2% by weight.

Incremental amounts of photocatalyst particles were added to a recirculating batch reactor fitted with a low pressure mercury lamp (principal emission at 254 nm) and the light intensity measured via a photoelectrochemical detector. Because the photocatalyst (anatase) is transparent to wavelengths longer than about 380 nm, and because the detector was rutile, a small constant amount of radiation having wavelengths longer than about 380 nm was un-attenuated by the anatase slurry. A correction was made for this transparency characteristic by subtracting a small constant from the raw data. A plot of natural log of fraction of light transmitted vs photocatalyst loading yielded a straight line. Thus the transmission, T, of the photocatalyst slurry can be described by the familiar expression:

\[ T = \frac{I}{I_0} = \exp(-AXC) \]  

(1)

The slope of this line is equal to A*X, where A is the absorption coefficient, X is the absorption thickness in cm, and C is the photocatalyst concentration in weight percent. For a titanium dioxide photocatalyst employed, a value of A equal to 48.8 cm⁻¹ wt %⁻¹ was obtained. Table 1 below is the calculated fraction of light transmitted, I/IO vs absorption thickness using the experimentally determined value of A in equation (1) for a photocatalyst loading of 0.2 wt % (nominal minimal loading for maximal efficiency). The important point is that of the incident light, 38% and 14% is transmitted, or 62% and 86% is absorbed within the first 0.1 and 0.2 cm, respectively. This thin illuminated region is the photoactive region fluid beyond this region is essentially in the dark, and little or no photocatalytic reactions occurs there.

**Table 1**

<table>
<thead>
<tr>
<th>X (cm)</th>
<th>T = \exp(-AXC)</th>
</tr>
</thead>
<tbody>
<tr>
<td>0.00</td>
<td>1</td>
</tr>
<tr>
<td>0.05</td>
<td>0.614</td>
</tr>
<tr>
<td>0.1</td>
<td>0.777</td>
</tr>
<tr>
<td>0.15</td>
<td>0.323</td>
</tr>
<tr>
<td>0.2</td>
<td>0.142</td>
</tr>
<tr>
<td>0.25</td>
<td>0.087</td>
</tr>
</tbody>
</table>

Thus, for example, if the slurry is about two inches deep within the CSTR 10, and the top surface of the slurry is irradiated with 254 nm light, it is seen from Table 1 above that only the top one or two millimeters of the slurry is photocatalytically active, and therefore the photocatalytic particles are decontaminating the contaminated fluid effectively only in that very thin upper region of the slurry.

It should be mentioned that for longer wavelengths radiation, such as solar radiation (300 to 400 nm), the penetration depth may be slightly greater owing to scattering dependence on wavelength and weaker attenuation of longer wavelength light by the photocatalyst.

The photocatalytic activity can take place very quickly in the one to two millimeter illuminated region, and therefore, it is desirable that portions of the slurry containing contaminated fluid be quickly moved into the one to two millimeter region of the upper surface of the slurry in order to achieve relatively quick and efficient decontamination of the fluid. This movement is accomplished by the generation of surface turbulence as shown in FIG. 3.

The inventors have constructed a pair of impellers oriented 180 degrees apart and rotatable about an axis oriented in substantially alignment with the longitudinal axis of the CSTR 10. Each impeller, which was fashioned out of 0.25 inch thick plastic and stepped down so that a smaller cross sectional area was presented to the fluid in a direction radially away from the axis of rotation, was rotated by a motor at a rate of angular speed approaching that which would quickly replenish the upper one to two millimeters of slurry surface with the contaminated fluid (shown in FIG. 3 as surface turbulence). It was found that upon approaching the revolution rate which causes adequate mixing, the impeller within the reactor 10 caused the undesirable effect of transferring significant amounts of angular momentum to the slurry (i.e., the impeller caused the slurry to circulate in the direction of rotation of the impeller). This resulted in the displacement of large amounts of slurry from near the center of rotation to the periphery of the CSTR 10 due to centrifugal forces (vortex formation). Also, a relatively great amount of energy is consumed due to the viscous drag on the rotation fluid caused by the walls of the reactor 10.

**Table 2**

<table>
<thead>
<tr>
<th>TEST NO.</th>
<th>REACTOR VOLUME (LITERS)</th>
<th>QUANTUM YIELD</th>
</tr>
</thead>
<tbody>
<tr>
<td>1</td>
<td>Front Illuminated</td>
<td>0.86</td>
</tr>
<tr>
<td>2</td>
<td>Front Illuminated</td>
<td>0.85</td>
</tr>
<tr>
<td>3</td>
<td>Front Illuminated</td>
<td>0.89</td>
</tr>
<tr>
<td>4</td>
<td>Front Illuminated</td>
<td>0.89</td>
</tr>
<tr>
<td>5</td>
<td>Front Illuminated</td>
<td>0.89</td>
</tr>
<tr>
<td>6</td>
<td>Annular (Cylconic)</td>
<td>0.79</td>
</tr>
<tr>
<td>7</td>
<td>Annular (35 mm)</td>
<td>0.7</td>
</tr>
<tr>
<td>8</td>
<td>Annular (35 mm)</td>
<td>0.7</td>
</tr>
<tr>
<td>9</td>
<td>Annular (38 mm)</td>
<td>0.845</td>
</tr>
<tr>
<td>10</td>
<td>Annular (38 mm)</td>
<td>0.845</td>
</tr>
<tr>
<td>11</td>
<td>Hemi./Jet</td>
<td>0.57</td>
</tr>
<tr>
<td>12</td>
<td>CSTR 45 RPM</td>
<td>1.6</td>
</tr>
<tr>
<td>13</td>
<td>Annular (35 mm)</td>
<td>0.7</td>
</tr>
<tr>
<td>14</td>
<td>Annular (35 mm)</td>
<td>0.7</td>
</tr>
<tr>
<td>15</td>
<td>Annular (38 mm)</td>
<td>0.85</td>
</tr>
</tbody>
</table>

**Compilation of Photocatalytically Decomposing TCE Data in Various Reactors**

<table>
<thead>
<tr>
<th>TEST NO.</th>
<th>REACTOR VOLUME (LITERS)</th>
<th>QUANTUM YIELD</th>
</tr>
</thead>
<tbody>
<tr>
<td>16</td>
<td>Annular (Cylconic)</td>
<td>0.79</td>
</tr>
<tr>
<td>17</td>
<td>Front Illuminated</td>
<td>0.89</td>
</tr>
<tr>
<td>18</td>
<td>Front Illuminated</td>
<td>0.89</td>
</tr>
<tr>
<td>19</td>
<td>CSTR 10</td>
<td>1.6</td>
</tr>
</tbody>
</table>

The inventors have designed several impellers that achieve the objectives of agitating the fluid surface to replenish the fluid surface with contaminated fluid, to maintain the semiconductor powder in a suspended state substantially uniformly throughout the fluid, to
nylon minimize the centrifugal effect on the slurry, and also to aerate the slurry (depicted as the water wake in FIG. 3). In order to alleviate the above problems, in another experiment a thirty-three inch internal diameter CSTR fitted with twenty-nine inches of 0.125 inch flexible nylon rod as the impeller utilized solar light to photodecompose TCE. These Q.Y.s are not directly comparable with those employing TCE but are internally consistent. In a literature study of the decomposition of chloroform (which has kinetics almost identical to TCE according to R. W. Matthews. J. Catal., 111, 264 (1988)) in an annular reactor, a Q.Y. of 0.036 was obtained by A. L. Pruden and D. F. Ollis, Environ. Sci. Technol., 17, 628 (1983). This reactor type, excluding designs by the inventors, represents state-of-the-art design as reported in the literature. The inventors have made many innovations in reactor design to increase reactor Q.Y. above 0.036, as evidenced in Table 2. Highest Q.Y. was obtained in a recirculating front illuminated reactor (Table 2, tests numbers 1-5). However, this reactor is an impractical configuration for scale-up. In the case of TCE, the CSTR (Table 2, test number 12) has exhibited the next highest Q.Y.s, which are similar to the best annular reactor design (Table 2, tests numbers 7-10 and 13-15). In the case of the decomposition of red food dye in the front-illuminated reactor, Q.Y.s of about 1 (Table 2, tests numbers 17-18) were obtained under solar and artificial lighting. For the CSTR a Q.Y. of 0.90 (Table 2, test number 19) was obtained. This demonstrates that the CSTR is approaching the efficiency of the highly efficient front-illuminated reactor and a factor of about 5 increase in efficiency over the cyclonic annular reactor (Table 2, test number 16). The salient point here is that the CSTR described above exhibits Q.Y.s far in excess of that described in the literature to date and that, in distinction from the highly efficient but impractical front-illuminated reactor, it is a practical configuration for scale-up. Table 2 also lists the volumes of water treated by the various batch reactors. For all the various annular reactors described and the front-illuminated reactor, a centrifugal pump powered by a 1/25 horse power electric motor was the primary source of mixing. All these reactors had fluid volumes of less than a liter. The CSTR, which had a 16 liter capacity, was stirred by a 1/25 horse power gear reduction motor. There was sufficient power for the motor to drive at least two similar CSTR reactors for a combined volume of 32 liters. Thus the CSTR is more efficient in its use of electrical power for mixing than the other reactors in Table 2 by about 3200%.

In yet another experiment, a twenty inch long tapered impeller made of fiberglass which had cross-sectional diameters of 0.22 and 0.010 inches near the center of rotation and at the distal end, respectively, was employed to mix a 42.5 inch diameter peripheral wall rotating at approximately 60 RPM. In his type of operation (hereinafter referred to as operation A) good surface boundary layer mixing was evident by the appearance of surface eddies and wavelets. High relative velocity between the impeller and the water was evidenced by the formation of a fluid envelope wake in the trailing edge of the impeller. Centrifugation of the fluid was also minimized. This demonstrates that most of the mechanical energy imparted to the fluid by the impeller was used for surface agitation and not the wasteful bulk rotation of the fluid. Q.Y.s were not measured. In yet another experiment, the fiberglass impeller described above was fashioned into a comb by epoxying 0.030 inch diameter wire at a ninety degree angle to the impeller at approximately 0.25 inch intervals. This modified impeller was operated first with both the fiberglass and the comb wires below the surface (hereinafter referred to as operation B) and also by elevating the impeller so that only the wires were submerged (hereinafter referred to as operation C). In operation B, the wires had the effect of breaking up the trailing edge air envelope and achieving better aeration of the fluid. In operation C, much higher revolution rates were achievable than in operations A or B with excellent surface mixing and with less centrifugation of the fluid evident than in operations A or B. Q.Y.s for these have not yet been measured for these operations. Although FIG. 1 schematically shows a pair of impellers disposed 180 degrees apart disposed within the CSTR and rotated about an axle aligned with the longitudinal axis of the CSTR, it should be appreciated that any number of impellers could be advantageously used. Generally, the larger the diameter of the reactor the greater the number of impellers needed for mixing. Each impeller possesses an inner end located at the center of rotation, and an outer end spaced slightly from the peripheral wall of the CSTR. Preferably the outer end of the impeller extends about 99% of the radial distance between the center of rotation of the peripheral wall of the CSTR. Preferably, the impeller is positioned essentially so that the impeller only skims or is slightly submerged beneath the slurry surface and is oriented substantially parallel to the slurry surface. The impeller may be rigid and may have a tapered thickness when viewed in the direction of rotation.

Several embodiments of the impeller are shown in FIGS. 4 through 13. There is shown in FIGS. 4A and 4B an impeller having a substantially uniform thickness from the inner end to the outer end thereof. The impeller possesses a series of apertures along its length, each aperture being substantially parallel to the direction of rotation of the impeller. The apertures are designed to permit certain portions of the upper slurry surface to pass therethrough and to create vortices and turbulence in the upper region of the slurry surface. Such turbulence permits circulation of slurry in the upper surface region, whereby contaminated fluid is circulated into the upper slurry surface region. The size of the apertures or the numbers of apertures may gradually vary from the inner end to the outer end of the
impeller 16 to take into account the greater linear speed at which the outer end of the impeller 16 is being rotated.

There is shown in FIGS. 5A and 5B an impeller 18 in all respects similar to the impeller 16, except that there are no apertures in the impeller 18 and the lower edge of the impeller 18 is serrated, (i.e., fashioned in a "saw tooth" configuration). Again, the lower end of the impeller 18 is designed to agitate the upper surface of the slurry to create turbulence therein.

There is shown in FIGS. 6A and 6B a tapered or conical rod shaped impeller 20, with the outer end having the smaller diameter. Again, such tapering takes into account the greater speed of the outer end of the impeller 20.

FIGS. 7A and 7B disclose a tapered rod type impeller 21 possessing a series of discs spaced along the impeller length. Each disc lies in a plane substantially perpendicular to the axis of the impeller 21. The purpose of the "washer" type discs is to break up the film of water attached to the trailing edge of the impeller 21, thus assisting the aeration and mixing of the slurry.

There is shown in FIGS. 8A and 8B an impeller 22 having a rectangular cross section that is gradually twisted 90 degrees from the inner end to the outer end thereof. Thus, the effective thickness of the impeller 22, when viewed in the direction of rotation, gradually tapers from a relatively great thickness at the inner end thereof to a relatively thin thickness at the outer end thereof.

There is shown in FIGS. 9A and 9B a telescopic, tapering rod type impeller 24 possessing four cylindrical segments arranged from the cylindrical segment having the greatest diameter to the cylindrical segment having the least diameter at the outer end thereof.

FIGS. 10A and 10B disclose a comb type impeller 25 utilized in operations A and B described above. As best shown in FIG. 10B the teeth of the comb like impeller 25 may be either vertically oriented or may be selectively, adjustably inclined.

FIG. 11 shows a pair of vertically spaced impellers 26, 27 disposed within a CSTR. Preferably one impeller 26 rotates in a direction opposite to the rotational direction of the other impeller 27. The lower impeller 27 helps mix the slurry and maintains the photocatalytic particles in suspension.

Ideally, the effective thickness of the impellers, as viewed in the direction of rotation, decreases away from the center of rotation. Basically, the frontal area presented to the slurry by the impeller should decrease in the direction moving away from the center of rotation. Also, depending upon the configuration of the impeller being used, the impeller should depend preferably a distance in the range of between one millimeter to five millimeters below the surface of the slurry. The impeller may be fashioned of rigid material. Three preferred materials for fashioning the impeller are stainless steel, fiberglass and carbon fiber. Depending upon the relative amount of contamination, the amount of photocatalytic particles, the degree of decontamination, etc., the slurry surface should be swept by an impeller in approximately a half of a second or at least frequently enough to preclude significant dampening of the surface disturbance.

There is shown in FIGS. 12A and 12B a two impeller system comprising an upper impeller and a lower impeller each possessing four blades oriented at ninety degree angles. The lower impeller has blades extending a relatively short radial distance, whereas the upper impeller has blades extending a relatively great radial distance. The lower impeller is mounted on an axle mounted concentrically within a hollow axle upon which the upper impeller is mounted. The axles are independently rotated, with the lower impeller, having the shorter radial blades, being rotated faster than the upper impeller. The two impeller system shown in FIGS. 12A and 12B helps insure that the slurry is suitably mixed (especially by the lower impeller) near the center of the CSTR. The two impeller system is most advantageously used where the diameter of the CSTR is relatively large.

Another impeller design is shown in FIG. 13 and utilizes compressed air or oxygen both to cause the impeller to rotate and to aerate or oxygenate the slurry. In this design, the impeller is positioned very near the bottom of the CSTR and presents a relatively narrow cross-section in the direction of rotation in order to minimize momentum transfer to the slurry. The impeller is essentially hollow or contains piping that is in fluid communication with a hollow axle through which the air or oxygen is transmitted. The trailing edges of the impeller are provided with orifices in communication with the hollow impeller interior or the piping within the impeller interior. The release of compressed air or oxygen from the orifices provides a jet propulsion for effecting the rotation of the impeller. The released air or oxygen also forms bubbles rising to the slurry surface, which causes slurry surface agitation and also assists in maintaining the suspension of photocatalytic powder within the slurry.

It should also be appreciated from the foregoing that ideally, the slurry within the CSTR possesses a relatively large area and a relatively small depth. This is so minimal energy is wasted unnecessarily mixing large volumes of slurry in the dark regions and so that thorough decontamination of the fluid may be achieved quickly. The depth of the slurry is preferably between one inch and ten inches, depending on the diameter of the CSTR, and the ratio of the area of the fluid slurry surface to the volume of the slurry is in the range of between substantially one/twelve inches to one/inches.

It should be further appreciated that the agitation and turbulence in the top surface of the slurry helps to maintain the semiconductor particles suspended substantially uniformly throughout the slurry, since the upper surface will be gradually transcribed through convective transfer to the other regions of the slurry, and also helps to aerate the slurry. Aeration is important because oxygen is a primary reactant that effects the degradation of the organics.

When a monitor (not shown) determines the degree of decontamination of the fluid has reached a desirable level, then the slurry is removed from the CSTR and is pumped by a centrifugal pump 28 to a cross flow filter 28 (See FIGS. 1 and 14), which separates and segregates the semiconductor particles from the decontaminated fluid (permeate). The cross flow filter 28 is configured analogous to a tube-in-shell heat exchanger except that the tubes 30 are constructed of a microporous polymer material, the pores 36 of which are constructed with a relatively larger amount of semiconductor powder in a relatively.
smaller amount of decontaminated fluid. A ball valve 32 disposed at the outlet end of the filter 28 restricts the flow of slurry therethrough, which in turn creates a back pressure within the tubes 30. An exit port 34 communicates with the interior of the filter 28 but external to the tubes 30, adjacent the inlet end of filter 28. Since the pressure within the exit port 34 is less than the pressure within the tubes 30, the liquid tends to flow through the pores 36 of the tubes 30 and into the exit port 34. Because the semiconductor powder particles are too large to pass through the pores 36, substantially only the decontaminated fluid passes through the pores 36 and into the exit port 34. The semiconductor powder particles tend to cake on and clog the pores 36 at the inner face within the tubes 30 in a relatively short period of time, thereby rendering the filter 28 ineffective. In accordance with the present invention, the filter 28 is back flushed so as to dislodge the semiconductor powder particles therefrom. Such a back flushing procedure has been used outside the field of the present invention. A cylinder 38 is in fluid communication with the interior of the filter 28 but external to the tubes 30, near the exit end of filter 28. A piston 40 is slideably disposed within the cylinder 38. The end of the cylinder 38 not in communication with the interior of the filter 28 is in communication with a three-way valve. The valve may be positioned so as to cause a source of compressed gas to communicate with the interior of the cylinder and to slide the piston within the cylinder 38 against the pressure of the permeate fluid within the cylinder 38. Alternatively, the three-way valve may be positioned so as to permit the compressed gas within the cylinder 38 to vent to the atmosphere. The back flush mechanism also includes a valve 42 that may open and close the fluid flow within the exit port 34. The filter 28 may be back flushed in accordance with the following operation. The valve 42 is closed, and then the three-way valve is positioned so that compressed gas acts upon the piston 40 to force the permeate fluid within the cylinder 38 back through the pores 36 within tubes 30. Because of the relatively lower pressure within tube 30, such movement of the piston 40 will cause a pressure pulse to be sharply transmitted through the pores 36 within tubes 30, in the reverse direction, which in turn tends to dislodge the semiconductor powder particles from the pores 36. After the pulse, the valve 42 is opened and the three-way valve is positioned in a vent mode, which allows the cylinder 38 to refill with the permeate fluid. It should be appreciated that a series of pulses may be generated within a short period of time such as a few seconds. Also, the pulsing may be selectively activated or may be controlled by a computer or like to occur at selected intervals. The decontaminated fluid drains from the exit port 34, whereas the slurry, now having a relatively high concentration of semiconductor particles, may be recirculated back to the CSTR 10, as shown in FIG. 1, or may be stored. If the slurry is recirculated to the CSTR 10, then such slurry is mixed with new contaminated fluid, and the process is repeated in a substantially continuous operation. The inventors had noticed anomalously slow decontamination of certain contaminated fluids that they tried to decontaminate using photocatalytic processes similar to those described above. In one anomalous trial the decomposition of aqueous TCE in deionized water (DI) was compared with its decomposition in ground waters taken from three different sampling wells, and it was noted that the decomposition of TCE in all the ground waters was slower than in the DI water. However the decomposition of TCE in one of the waters was particularly slow. Analysis of the ground waters revealed that there were relatively high concentrations (about 2–3 milligrams per liter) of chromium (VI), which later was discovered as having caused the decreased photocatalytic activity. (One of the inventors has shown that cations from metals in group IIA and IIA in the periodic table such as sodium, potassium, magnesium, etc. and anions such as sulfate, carbonate, chloride and others do not significantly affect photocatalytic reaction rates, G. COOPER and A. J. NOZIK, final report to the Environmental Protection Agency, IAG NO. DW89931800-01-1, "Novel And Simple Approach To Elimination Of Dilute Toxic Wastes Based On Photoelectrochemical Systems" (1987)). In other experiments, the photocatalyst was used to decompose 100 PPM TCE in waters, separated from the contaminated fluid that was photocatalytically treated, washed several times with pure water, and then reused to purify identical waters. In one of the waters, the photocatalyst could be successfully recycled four times without significant loss of activity. However, for another water, which exhibited the anomaly, almost complete loss of photocatalytic activity occurred after the first use. Atomic absorption analysis of the photocatalyst from the other water indicated almost quantitative recovery of chromium from the particles' surfaces. This was the first reported demonstration of the photocatalytic removal of chromium (VI) from water and its inhibiting effect on the decomposition of aqueous organics. A copy of the results of these anomalous tests are being submitted with the patent application and form part of the file wrapper. Other metallic ions so far discovered by the inventors that inhibit the photocatalytic decomposition of organics when present in solution at relatively low concentrations on the order of a few milligrams per liter and less, besides chromium (VI), are chromium (III), lead (II), and copper (II). The rate inhibiting effect of these metal ions, at concentrations of 1 and 10 PPM concentrations, on the decomposition of TCE is shown in several graphs submitted with the present application to form part of the file wrapper. In order to demonstrate that the inhibition of the photocatalytic decomposition of organics by the above metal ions, when present in solution, was universal and not just limited to the decomposition of TCE, the decomposition of aqueous benzene, toluene, xylene and phenol mixture at 50 PPM total organic carbon concentration was investigated in the presence of the above metal ions at 10 PPM concentration. Significant diminishment in photocatalytic activity was caused by the presence of chromium (III), chromium (VI) and lead (II). Copper (II), iron (II) and cadmium (II) caused a slight decrease in decomposition rates. Mercury (II) did not affect reaction rates. The inventors have reason to believe in some cases that these ions cling to and are adsorbed by the semiconductor particles, thereby rendering the semiconductor powders ineffective for photocatalysis. In other cases the free metals may be photodeposited from the ions by photoelectrochemical reduction onto the particles' surfaces In other cases the metal oxide (or hydroxide) may be photodeposited by reductive or oxidative processes onto the photocatalyst particles' surfaces. And in yet other cases, the metal ions or their oxides or hydroxides.
may act as a reductant and next as an oxidant, thereby effectively causing the recombination of the photogenerated charge carriers and their wastage into heat. Additionally, besides significantly diminishing the rate of organic decomposition, the deposited metal ions/ metals/oxides/hydroxides can also poison the photocatalyst thereby making the photocatalyst ineffective for repeated photocatalytic destruction of organics. In catalytic technology, all the above postulated mechanisms of rate decrease due to the presence of a rate inhibiting contaminant is considered “poisoning”. Thus, the inventors believe that in order to achieve relatively rapid decontamination from organics of fluids containing such metal ions and to avoid premature photocatalyst poisoning, the deleterious metal ions should first be removed from the contaminated fluid before the fluid is subjected to photocatalytic decontamination from organics. Although such ions might be removed in a host of different ways, including but not limited to ion-exchange resins, activated carbon and electrolysis, and although these techniques might be employed in conjunction with the present photocatalytic invention, the present invention contemplates that the contaminated fluid including the metal ions is first formed as part of a slurry or immobilized structure with semiconductor powder particles, which function not as a photocatalyst for effecting the oxidation of aqueous organics or microorganisms, but as particles to remove the metal ions. In the case of the slurry, it can then be filtered in the same manner as described above, and the semiconductor particles are then stored or recycled for further metal ion removal. In order to demonstrate the rate enhancement of organic oxidation obtained by photocatalytically pretreating metal ion contaminated waters, the water referenced above, containing chromium (VI), was first passed through a UV irradiated module that contained immobilized photocatalyst. After this pretreatment, the water was spiked with TCE and the aqueous TCE was subsequently photocatalytically decomposed. Yet another graph submitted with the patent application and forming part of the file wrapper shows that the decomposition of TCE is faster in the pretreated water than in the untreated water. More experiments by the inventors have shown that although the metals contaminated photocatalyst may be inactive for further organic destruction, its activity for further metal ion removal has not been significantly impaired. Thus, in a practical system, photocatalyst which will inevitably lose its activity as a result of trace metal deposition, even with metal ion pretreatment, can be recycled for use in the metal ion removal pretreatment step. Also, even after the photocatalyst has been sufficiently loaded with metals to render it completely useless for metal removal, the inventors have shown that it may be recycled by treatment with acid solutions such as nitric or hydrochloric acids. These acid treatments dissolve the deposited metal ions/metal oxides/metal hydroxides, thus regenerating the photocatalyst. The contaminated fluid (absent of the metal ions) is then treated according to the photocatalytic process previously described above.

FIG. 15 shows a simple photocatalytic decontamination system including a reactor module, defined as two CSTRs 100, 102 and one cross-flow filter (CFF) 104, for an ideal situation wherein the water to be decontaminated is free of poisoning metal ions. In this case the water and slurry flow co-currently since poisoning of the catalyst is not a problem. The purpose of employing two CSTRs in a module is that in a continuous process, fresh contaminated fluid is continuously entering the system and, because of the vagaries of fluid flow, a concentrated plume of contaminated fluid could exit in the first CSTR. By using two CSTRs in series, the second reactor acts as a buffer volume for a high concentration spike by providing a second stage of dilution. FIG. 16 is an extension of the ideal case wherein the number of CSTRs has been increased to increase the capacity of the system, but all other features are the same as in FIG. 15.

In a non-ideal situation wherein the water to be decontaminated contains metal ion co-contaminants that may poison the photocatalyst, it is necessary to prevent the migration of those metal ions downstream through the system, in order to achieve optimal photocatalytic oxidation efficiency of the contaminant organics. In this case a different operational strategy must be employed; this strategy involves the use of a pretreatment reactor and counter-current flow of the catalyst and water. The pretreatment reactor substantially removes the metal ion poisons before the water enters the organic oxidation modules, and counter-current flow ensures that any metal ions that slip through do not contaminate the rest of the system. Another benefit of counter-current operation include optimum catalyst activity in the last module before the water leaves the system. The partially deactivated photocatalyst moves “upstream” into the next more highly contaminated reactor wherein the less than optimal activity photocatalyst can still display high efficiency with the higher concentration organic. In this manner the gradually deactivating photocatalyst is pumped upstream. Ultimately, the photocatalyst is pumped into the pretreatment reactor where the catalyst may still have considerable capacity to remove metal ions even though its ability to oxidize organics is substantially diminished.

Pretreatment reactor CSTR 90 for the removal of metal ions is shown in FIG. 17. Its operation is substantially the same as the CSTRs described above, however its primary purpose is to remove metal ions from the incoming fluid and prevent the metal ions from poisoning the photocatalyst in the subsequent CSTRs. In a counter-current mode, the CSTR 90 will have two influent streams first a partulates free stream 200 from the contaminated water storage tank 50, and second, a partially decontaminated slurry stream from the first CSTR module 54 via CFF 82. In a manner analogous to the operation of the other CSTRs, the slurry is mixed and illuminated, thus removing the metals by photoelectrodeposition and adsorption. The metals decontaminated water is separated from the photocatalyst by circulation through CFF 96 by pump 94. The filtrate passes through a three-way solenoid valve 98 which directs the filtrate either through metal ion sensor 100 and on to the first CSTR module 54 for organics decontamination, or back to CSTR 90 if the metal ion sensor determines that the pretreatment has not met specifications. A ball valve 102 sets the slurry side of CFF 96 back pressure, which determines the filtration rate. A three-way solenoid valve 104 directs the concentrated slurry either back to the CSTR 90 or to a catalyst concentrator/recovery unit (not shown), off line of the main system, when the metals removal capacity of the photocatalyst has been reached.

There is shown in FIG. 18 a system including a pair of CSTRs 54,60 and CFFs 88,82 such as described above for decontaminating the organics contaminated.
water in the counter-current mode. The two CSTRs 54 and 60 and one CFF 68, within the outlined box, are the basic counter-current flow modular unit of the system, that can be extended to whatever number of modules necessary for a particular decontamination problem. The CSTRs decontaminate the water progressively wherein the first CSTR 54 may decontaminate the water partially and the second CSTR 60 finishes the decontamination. The FIG. 18 does not include a pre-treatment step for removing certain metallic ions from the contaminated fluid. The pre-treatment reactor for metal ion removal was discussed above with reference to FIG. 17, the present description assumes that the organics contaminated water is substantially free of interfering metal ions. The overall system includes a storage reservoir 50 in which the contaminated water is initially stored. The contaminated water is pumped from the reservoir 50 by means of a pump 52 to a CSTR 54. A monitor, such as a total organic carbon sensor 56 monitors the degree of contamination of the water entering the CSTR 54. The two CSTRs 54, 60 are in fluid communication via balance tube 58 which allows the partially decontaminated slurry to flow from CSTR 54 to CSTR 60 as decontaminated water is removed from CSTR 60. Decontaminated slurry is removed from CSTR 60 through pre-filter 62 by pump 64 and pumped through three-way solenoid valve 66, the position of which determines whether the slurry flows to CFF 68 or to the automated catalyst feeder (ACF) 70. Another monitor 76, such as a total organic carbon sensor, samples the clear decontaminated water (filtrate) leaving the CFF 68, and if the decontamination has not reached an acceptable level, then the monitor 76 will cause the pump 64 to shut off for a period of time to allow further decontamination. If the monitor 76 detects an acceptable level of decontamination, then the slurry will be circulated through the CFF 68 for separation of the photocatalyst from the decontaminated water which flows out of the system. The slurry (i.e., retentate) leaving the CFF 68 flows to a ball valve 72, which sets the CFF 68 back pressure, and on to a three-way valve 74, the position of which determines whether the slurry is recirculated back to the CSTR 60 or is directed to CSTR 54. Flow to CSTR 54 effects counter-current flow of the photocatalyst relative to the flow of the progressively cleaner water.

The following sub-systems for photocatalyst ingress and egress are not part of the module but are required for the complete continuous system operating in a counter-current mode. Only one additional CFF 82 would be required for the first reactor for photocatalyst removal and one ACF required on the last reactor for catalyst addition When fresh catalyst is required to be added to CSTR 60 as determined by monitor 76 which tracks decontamination level as a function of time, three-way valve 66 switches to the position to allow slurry flow to the ACF 70 for the addition of fresh photocatalyst. Three-way valve 66 then switches to direct slurry flow through CFF 68 and three-way valve 74 switches positions to direct slurry flow to CSTR 54 for a period of time, thus moving relatively concentrated slurry (retentate) "up-stream". Simultaneously, pump 80 is activated, which pumps slurry from CSTR 54 to CFF 82, the back pressure of which is set by ball valve 84. The relatively concentrated slurry (retenate) is then directed from the ball valve 84 to a catalyst concentrator/recovery unit (not shown); alternatively the slurry may be directed to a metals removal pre-treatment reactor (also not shown). The filtrate is directed back to CSTR 54.

FIG. 19 is a block diagram illustrating a complete counter-current system. The reference numerals 300, 302, 304 each represent a module defined as two CSTRs and one CFF; any number of modules may be used in series as required for a particular problem. The reference numeral 306 represents a pretreatment reactor as defined as one CSTR and one CFF; the reference numeral 308 represents a photocatalyst concentrator/recovery unit where the spent catalyst is removed from the system; and the reference numeral 310 represents a ACF for introducing fresh catalyst to the system. The solid lines indicate photocatalyst free water flows and the lines with cross hatching indicate slurry flows. Contaminated water enters pretreatment reactor 306 where metal ions are removed by photocatalyst that has already seen duty for organics oxidation in the modules 300, 302, 304 and may be partially deactivated towards photocatalysis but still has capacity to remove metal ions. The filtrate from pretreatment number 306 flows to 300 where organics oxidation begins. The filtrate flows to the next module 302, then to the next module 304, and eventually out of the system as pure water. The retentates flow counter-currently from the modules 304, 302, 300 and on to the pretreatment reactor 306; eventually the retentate is transferred to the photocatalyst concentrates recovery unit 308 where the spent photocatalyst is removed from the system. The ACF 310 adds fresh photocatalyst as necessary to the last module 304 by mixing the photocatalyst powder into slurry pumped from the last module 304 into the ACF 310 and back to module 304.

Although particular embodiments of the present invention have been described and illustrated herein, it should be recognized that modifications and variations may readily occur to those skilled in the art and that such modifications and variations may be made without departing from the spirit and scope of our invention. Consequently, our invention as claimed below may be practiced otherwise than as specifically described above.

We claim:

1. A method of decontaminating a contaminated fluid by using photocatalytic particles comprising the steps of:

   - suspending photocatalytic particles in a contaminated fluid to form a slurry;
   - illuminating the slurry with light to photocatalytically activate said photocatalytic particles and thereby substantially decontaminate said contaminated fluid;
   - filtering the decontaminated fluid and the photocatalytic particles suspended therein in a substantially continuous operation to segregate said decontaminated fluid substantially completely from the photocatalytic particles;
   - changing the direction of the fluid which has passed through the filter to cause the fluid to flow back through the filter and dislodge any photocatalytic particles from the filter which have become lodged therein;
   - collecting the dislodged photocatalytic particles; and
   - collecting the fluid which has passed through the filter.

2. A method according to claim 1 further comprising the step of suspending the collected photocatalytic particles in contaminated fluid.
3. A method according to claim 1 further comprising the steps of:

- forming a second slurry of the collected fluid which has passed through the filter and additional photocatalytic particles; and
- illuminating the second slurry with light to photocatalytically activate the additional photocatalytic particles and thereby further decontaminate the collected fluid.

4. A method of decontaminating a contaminated fluid containing metal ions selected from the group consisting of mercury (II), chromium (VI) and (II), lead (II), copper (II), and iron (II) by using a first and second set of photocatalytic particles comprising the steps of:

- suspending the first set of photocatalytic particles in the contaminated fluid containing the metal ions to create a first slurry;
- illuminating the first slurry with light to photocatalytically activate the first set of photocatalytic particles to cause the metal ions to associate with the first set of photocatalytic particles and partially decontaminate the contaminated fluid;
- filtering the first slurry to separate the partially decontaminated fluid from the first set of photocatalytic particles and metal associated therewith;
- collecting the partially decontaminated fluid;
- suspending the second set of photocatalytic particles in the partially decontaminated fluid to create a second slurry;
- illuminating the second slurry with light to photocatalytically activate the second set of photocatalytic particles to further decontaminate the partially decontaminated fluid; and
- filtering the second slurry to separate the further decontaminated fluid and the second set of photocatalytic particles.

5. The method of claim 4 further comprising the steps of:

- changing the direction of the partially decontaminated fluid which has passed through the filter to cause the partially decontaminated fluid to flow back through the filter and dislodge any of the second set of photocatalytic particles which have become lodged in the filter; and
- collecting the dislodged second set of photocatalytic particles.

6. The method of claim 4 further comprising the steps of:

- forming a second slurry of the collected fluid which has passed through the filter to cause the further decontaminated fluid to flow back through the filter and dislodge any of the second set of photocatalytic particles which have become lodged in the filter; and
- collecting the dislodged second set of photocatalytic particles.

7. The method of claim 6 further comprising the steps of:

- suspending the collected second set of photocatalytic particles in a contaminated fluid to create a third slurry.

8. A method of decontaminating a contaminated fluid containing metal ions selected from the group consisting of mercury (II), chromium (VI) and (II), lead (II), copper (II), and iron (II) by using a first set of photocatalytic particles comprising the steps of:

- suspending the first set of photocatalytic particles in the contaminated fluid containing metal ions to form a first slurry;
- illuminating the first slurry with light to photocatalytically activate said first set of photocatalytic particles to cause the metal ions to associate with the first set of photocatalytic particles; and
- filtering the first slurry in a substantially continuous operation to segregate the fluid of the first slurry from the first set of photocatalytic particles and metal associated therewith;
- collecting the partially decontaminated fluid from the first set of photocatalytic particles and metal associated therewith;
- changing the direction of the fluid which has passed through the filter to cause the fluid to flow back through the filter and dislodge any of the second set of photocatalytic particles and metal associated therewith from the filter which have become lodged therein; and
- collecting the dislodged photocatalytic particles and metal associated therewith; and
- collecting the fluid which has passed through the filter.

9. A method according to claim 8 further comprising the steps of:

- forming a second slurry of the collected fluid which has passed through the filter and a second set of photocatalytic particles; and
- illuminating the second slurry with light to photocatalytically activate the additional photocatalytic particles and decontaminate the collected fluid.

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